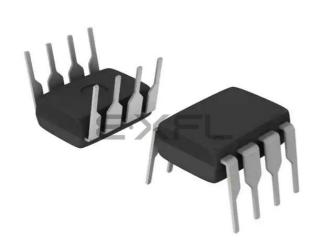
E·XFL



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	AVR
Core Size	8-Bit
Speed	10MHz
Connectivity	SPI
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	3
Program Memory Size	2KB (1K x 16)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C
Mounting Type	Through Hole
Package / Case	8-DIP (0.300", 7.62mm)
Supplier Device Package	8-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at90s2323-10pi

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



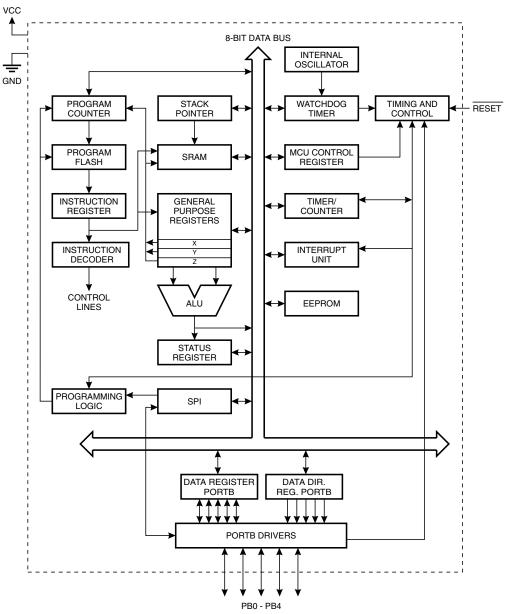
Description

The AT90S/LS2323 and AT90S/LS2343 are low-power, CMOS, 8-bit microcontrollers based on the AVR RISC architecture. By executing powerful instructions in a single clock cycle, the AT90S2323/2343 achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.

The AVR core combines a rich instruction set with 32 general-purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.



Figure 1. The AT90S/LS2343 Block Diagram

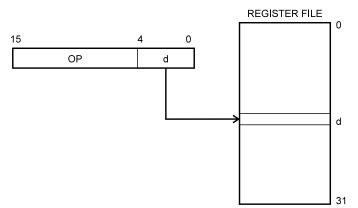


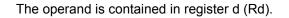


Program and Data Addressing Modes The AT90S2323/2343 AVR RISC microcontroller supports powerful and efficient addressing modes for access to the program memory (Flash) and data memory. This section describes the different addressing modes supported by the AVR architecture. In the figures, OP means the operation code part of the instruction word. To simplify, not all figures show the exact location of the addressing bits.

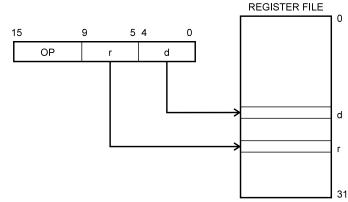
Figure 10. Direct Single Register Addressing

Register Direct, Single Register Rd





Register Direct, Two Registers Figure 11. Direct Register Addressing, Two Registers Rd and Rr

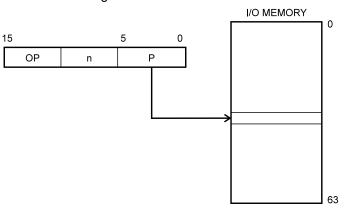


Operands are contained in register r (Rr) and d (Rd). The result is stored in register d (Rd).

AT90S/LS2323/2343

I/O Direct

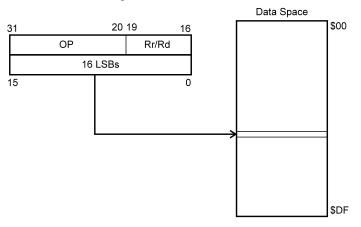
Figure 12. I/O Direct Addressing



Operand address is contained in six bits of the instruction word. n is the destination or source register address.

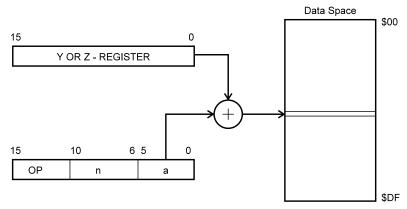
Data Direct

Figure 13. Direct Data Addressing



A 16-bit data address is contained in the 16 LSBs of a 2-word instruction. Rd/Rr specify the destination or source register.





Operand address is the result of the Y- or Z-register contents added to the address contained in six bits of the instruction word.



Data Indirect with Displacement



The most typical program setup for the Reset and Interrupt vector addresses are:

Address	Labels	Code	Comments
\$000		rjmp RESET	; Reset Handler
\$001		rjmp EXT_INTO	; IRQ0 Handler
\$002		rjmp TIM_OVF0	; Timer0 Overflow ; Handler;
\$003	MAIN:	ldi r16, low(RAMEND) out SPL, r16 <instr> xxx</instr>	; Main program start

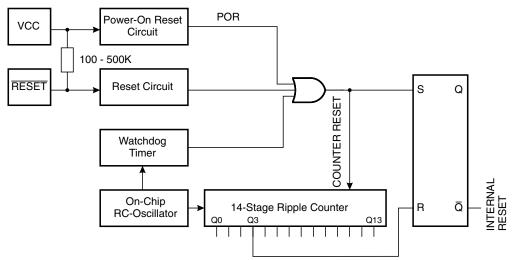
Reset Sources

The AT90S2323/2343 provides three sources of reset:

- Power-on Reset. The MCU is reset when the supply voltage is below the Power-on Reset threshold (V_{POT}).
- External Reset. The MCU is reset when a low level is present on the RESET pin for more than 50 ns.
- Watchdog Reset. The MCU is reset when the Watchdog timer period expires and the Watchdog is enabled.

During reset, all I/O registers are set to their initial values and the program starts execution from address \$000. The instruction placed in address \$000 must be an RJMP (relative jump) instruction to the reset handling routine. If the program never enables an interrupt source, the interrupt vectors are not used and regular program code can be placed at these locations. The circuit diagram in Figure 24 shows the reset logic. Table 4 defines the timing and electrical parameters of the reset circuitry.

Figure 24. Reset Logic

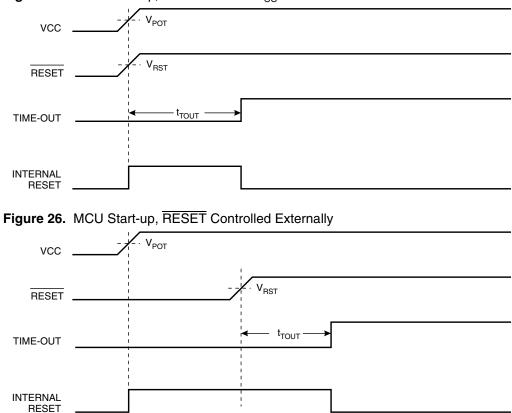


The AT90S/LS2323 has a programmable start-up time. A fuse bit (FSTRT) in the Flash memory selects the shortest start-up time when programmed ("0"). The AT90S/LS2323 is shipped with this bit unprogrammed.

The AT90S/LS2343 has a fixed start-up time.







External Reset

An external reset is generated by a low level on the $\overrightarrow{\text{RESET}}$ pin. Reset pulses longer than 50 ns will generate a reset, even if the clock is not running. Shorter pulses are not guaranteed to generate a reset. When the applied signal reaches the Reset Threshold Voltage (V_{RST}) on its positive edge, the delay timer starts the MCU after the Time-out period t_{TOUT} has expired.



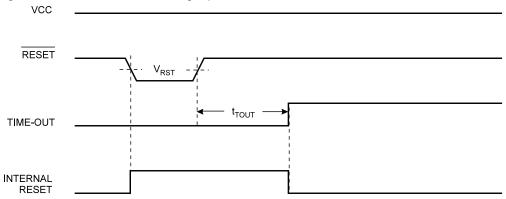




Table 8. Reset Source Identification

PORF	EXTRF	Reset Source
0	0	Watchdog Reset
0	1	External Reset
1	0	Power-on Reset
1	1	Power-on Reset

Interrupt Handling

The AT90S2323/2343 has two 8-bit interrupt mask control registers; GIMSK (General Interrupt Mask register) and TIMSK (Timer/Counter Interrupt Mask register).

When an interrupt occurs, the Global Interrupt Enable I-bit is cleared (zero) and all interrupts are disabled. The user software can set (one) the I-bit to enable nested interrupts. The I-bit is set (one) when a Return from Interrupt instruction (RETI) is executed.

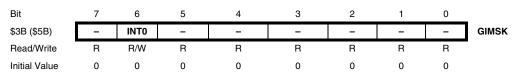
When the Program Counter is vectored to the actual interrupt vector in order to execute the interrupt handling routine, hardware clears the corresponding flag that generated the interrupt. Some of the interrupt flags can also be cleared by writing a logical "1" to the flag bit position(s) to be cleared. If an interrupt condition occurs when the corresponding interrupt enable bit is cleared (zero), the interrupt flag will be set and remembered until the interrupt is enabled or the flag is cleared by software.

If one or more interrupt conditions occur when the global interrupt enable bit is cleared (zero), the corresponding interrupt flag(s) will be set and remembered until the global interrupt enable bit is set (one) and will be executed by order of priority.

Note that external level interrupt does not have a flag and will only be remembered for as long as the interrupt condition is active.

Note that the Status Register is not automatically stored when entering an interrupt routine and restored when returning from an interrupt routine. This must be handled by software.

General Interrupt Mask Register – GIMSK



• Bit 7 – Res: Reserved Bit

This bit is a reserved bit in the AT90S2323/2343 and always reads as zero.

• Bit 6 – INT0: External Interrupt Request 0 Enable

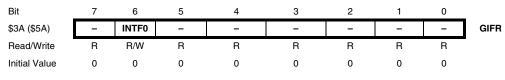
When the INT0 bit is set (one) and the I-bit in the Status Register (SREG) is set (one), the external pin interrupt is enabled. The Interrupt Sense Control0 bits 1/0 (ISC01 and ISC00) in the MCU general Control Register (MCUCR) define whether the external interrupt is activated on rising or falling edge of the INT0 pin or level sensed. Activity on the pin will cause an interrupt request even if INT0 is configured as an output. The corresponding interrupt of External Interrupt Request 0 is executed from program memory address \$001. See also "External Interrupts."

Bits 5..0 – Res: Reserved Bits

These bits are reserved bits in the AT90S2323/2343 and always read as zero.

AT90S/LS2323/2343

General Interrupt Flag Register – GIFR



• Bit 7 – Res: Reserved Bit

This bit is a reserved bit in the AT90S2323/2343 and always reads as zero.

• Bit 6 – INTF0: External Interrupt Flag0

When an edge on the INTO pin triggers an interrupt request, the corresponding interrupt flag, INTFO becomes set (one). If the I-bit in SREG and the corresponding interrupt enable bit, INTO in GIMSK, is set (one), the MCU will jump to the interrupt vector. The flag is cleared when the interrupt routine is executed. Alternatively, the flag is cleared by writing a logical "1" to it. This flag is always cleared when INTO is configured as level interrupt.

• Bits 5..0 - Res: Reserved Bits

These bits are reserved bits in the AT90S2323/2343 and always read as zero.

Timer/Counter Interrupt Mask

Register – TIMSK

Bit	7	6	5	4	3	2	1	0	_
\$39 (\$59)	-	-	-	-	-	-	TOIE0	-	TIMSK
Read/Write	R	R	R	R	R	R	R/W	R	-
Initial Value	0	0	0	0	0	0	0	0	

• Bits 7..2 - Res: Reserved Bits

These bits are reserved bits in the AT90S2323/2343 and always read zero.

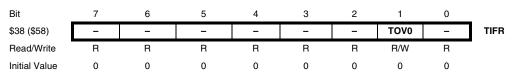
• Bit 1 – TOIE0: Timer/Counter0 Overflow Interrupt Enable

When the TOIE0 bit is set (one) and the I-bit in the Status Register is set (one), the Timer/Counter0 Overflow interrupt is enabled. The corresponding interrupt (at vector \$002) is executed if an overflow in Timer/Counter0 occurs, i.e., when the Overflow Flag (Timer/Counter0) is set (one) in the Timer/Counter Interrupt Flag Register (TIFR).

• Bit 0 - Res: Reserved Bit

This bit is a reserved bit in the AT90S2323/2343 and always reads as zero.

Timer/Counter Interrupt FLAG Register – TIFR



• Bits 7..2 - Res: Reserved Bits

These bits are reserved bits in the AT90S2323/2343 and always read zero.

• Bit 1 – TOV0: Timer/Counter0 Overflow Flag

The bit TOV0 is set (one) when an overflow occurs in Timer/Counter0. TOV0 is cleared by hardware when executing the corresponding interrupt handling vector. Alternatively, TOV0 is cleared by writing a logical "1" to the flag. When the SREG I-bit and TOIE0 (Timer/Counter0 Overflow Interrupt Enable) and TOV0 are set (one), the Timer/Counter0 Overflow Interrupt is executed.



activate the interrupt are defined in Table 9. The value on the INT01 pin is sampled before detecting edges. If edge or toggle interrupt is selected, pulses that last longer than one clock period will generate an interrupt. Shorter pulses are not guaranteed to generate an interrupt. If low-level interrupt is selected, the low level must be held until the completion of the currently executing instruction to generate an interrupt.

ISC01	ISC00	Description				
0	0	The low level of INT0 generates an interrupt request.				
0	1	Reserved				
1	0	The falling edge of INT0 generates an interrupt request.				
1	1	The rising edge of INT0 generates an interrupt request.				

Sleep Modes To enter the sleep modes, the SE bit in MCUCR must be set (one) and a SLEEP instruction must be executed. If an enabled interrupt occurs while the MCU is in a sleep mode, the MCU awakes, executes the interrupt routine and resumes execution from the instruction following SLEEP. The contents of the register file, SRAM and I/O memory are unaltered. If a reset occurs during Sleep mode, the MCU wakes up and executes from the Reset vector.

Idle Mode When the SM bit is cleared (zero), the SLEEP instruction forces the MCU into the Idle mode, stopping the CPU but allowing Timer/Counters, Watchdog and the interrupt system to continue operating. This enables the MCU to wake up from external triggered interrupts as well as internal ones like Timer Overflow interrupt and Watchdog reset.

Power-down Mode When the SM bit is set (one), the SLEEP instruction forces the MCU into the Powerdown mode. In this mode, the external oscillator is stopped while the external interrupts and the Watchdog (if enabled) continue operating. Only an external reset, a Watchdog reset (if enabled), or an external level interrupt on INTO can wake up the MCU.

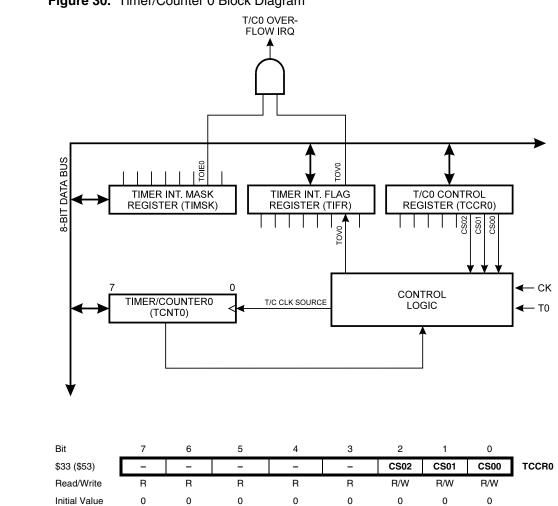
Note that if a level-triggered interrupt is used for wake-up from Power-down mode, the changed level must be held for some time to wake up the MCU. This makes the MCU less sensitive to noise. The changed level is sampled twice by the Watchdog oscillator clock and if the input has the required level during this time, the MCU will wake up. The period of the Watchdog oscillator is 1 µs (nominal) at 5.0V and 25°C. The frequency of the Watchdog oscillator is voltage-dependent as shown in section "Typical Characteristics" on page 49.

When waking up from Power-down mode, a delay from the wake-up condition occurs until the wake-up becomes effective. This allows the clock to restart and become stable after having been stopped. The wake-up period is equal to the clock reset period, as shown in Table 4 and Table 5 on page 21.

If the wake-up condition disappears before the MCU wakes up and starts to execute, e.g., a low-level on is not held long enough, the interrupt causing the wake-up will not be executed.







• Bits 7..3 - Res: Reserved Bits

These bits are reserved bits in the AT90S2323/2343 and always read zero.

• Bits 2, 1, 0 – CS02, CS01, CS00: Clock Select0, Bits 2, 1 and 0

The Clock Select0 bits 2, 1 and 0 define the prescaling source of Timer/Counter0.

Table 10. Clock 0 Prescale Select

CS02	CS01	CS00	Description
0	0	0	Stop, the Timer/Counter0 is stopped.
0	0	1	СК
0	1	0	CK/8
0	1	1	CK/64
1	0	0	CK/256
1	0	1	CK/1024
1	1	0	External Pin T0, falling edge
1	1	1	External Pin T0, rising edge



Timer/Counter0 Control Register – TCCR0



Port B Input Pins Address – PINB

Bit	7	6	5	4	3	2	1	0	_
\$16 (\$36)	-	-	-	PINB4	PINB3	PINB2	PINB1	PINB0	PINB
Read/Write	R	R	R	R	R	R	R	R	
Initial Value	0	0	0	N/A	N/A	N/A	N/A	N/A	

The Port B Input Pins address (PINB) is not a register and this address enables access to the physical value on each Port B pin. When reading PORTB, the Port B Data Latch is read and when reading PINB, the logical values present on the pins are read.

Port B as General Digital All pins in port B have equal functionality when used as digital I/O pins.

PBn, general I/O pin: The DDBn bit in the DDRB register selects the direction of this pin, if DDBn is set (one), PBn is configured as an output pin. If DDBn is cleared (zero), PBn is configured as an input pin. If PORTBn is set (one) when the pin is configured as an input pin, the MOS pull-up resistor is activated. To switch the pull-up resistor off, the PORTBn has to be cleared (zero) or the pin has to be configured as an output pin. The port pins are tri-stated when a reset condition becomes active, even if the clock is not running.

DDBn	PORTBn	I/O	Pull-up	Comment					
0	0	Input	No	Tri-state (high-Z)					
0	1	Input	Yes	PBn will source current if ext. pulled low					
1	0	Output	No	Push-pull Zero Output					
1	1	Output	No	Push-pull One Output					

Table 13. DDBn Effects on Port B Pins

Alternate Functions of Port B

B The alternate pin functions of Port B are as follows:

• CLOCK – Port B, Bit 3

Clock input: AT90S/LS2343 only. When the RCEN fuse is programmed and the device runs from the internal RC oscillator, this pin is a general I/O pin. When the RCEN fuse is unprogrammed, an external clock source must be connected to CLOCK.

• SCK/T0 – Port B, Bit 2

In Serial Programming mode, this bit serves as the serial clock input, SCK.

During normal operation, this pin can serve as the external counter clock input. See the timer/counter description for further details. If external timer/counter clocking is selected, activity on this pin will clock the counter even if it is configured as an output.

• MISO/INT0 - Port B, Bit 1

In Serial Programming mode, this bit serves as the serial data output, MISO.

During normal operation, this pin can serve as the external interrupt0 input. See the interrupt description for details on how to enable this interrupt. Note that activity on this pin will trigger the interrupt even if the pin is configured as an output.

• MOSI – Port B, Bit 0

In Serial Programming mode, this pin serves as the serial data input, MOSI.

Memory Programming

Program and Data Memory Lock Bits

The AT90S2323/2343 MCU provides two Lock bits that can be left unprogrammed ("1") or can be programmed ("0") to obtain the additional features listed in Table 14. The Lock bits can only be erased with the Chip Erase operation.

Table 14. Lock Bit Protection Modes

		Memory Lock Bits						
	Mode	LB1	LB2	Protection Type				
	1	1	1	No memory lock features enabled.				
	2	0	1	Further programming of the Flash and EEPROM is disabled. ⁽¹⁾				
	3	0	0	Same as mode 2, and verify is also disabled.				
	Note:			oltage Serial Programming mode, further programming of the Fuse bits bled. Program the Fuse bits before programming the Lock bits.				
Fuse Bits in	The AT9	0S/LS2	323 ha	s two Fuse bits, SPIEN and FSTRT.				
AT90S/LS2323	aree	enabled	. Defau	use is programmed ("0"), Serial Program and Data Downloading It value is programmed ("0"). This bit is not accessible in the low- ramming mode.				
	• When the FSTRT Fuse is programmed ("0"), the shortest start-up time is selected as indicated in Table 6 on page 21. Default value is programmed ("0"). Changing the FSTRT Fuse does not take effect until the next Power-on Reset. In AT90S/LS2343 the start-up time is fixed.							
	The state	us of th	e Fuse	bits is not affected by Chip Erase.				
Fuse Bits in	The AT9	0S/LS2	343 ha	s two Fuse bits, SPIEN and RCEN.				
AT90S/LS2343	• Whe are e	n the S enabled	PIEN F . Defau	Fuse is programmed ("0"), Serial Program and Data Downloading lt value is programmed ("0"). This bit is not accessible in the low- gramming mode.				
	the N value RCE	ACU clo e is un- N Fuse	ock sou progran e does r	N Fuse is programmed ("0"), the internal RC oscillator is selected as source. Default value is programmed ("0") in AT90LS2343-1. Default grammed ("1") in AT90LS2343-4 and AT90S2343-10. Changing the es not take effect until the next Power-on Reset. AT90S/LS2323 e internal RC oscillator as the MCU source.				
	The state	us of th	e Fuse	bits is not affected by Chip Erase.				
Signature Bytes	All Atmel microcontrollers have a three-byte signature code that identifies the d The three bytes reside in a separate address space. For the AT90S/LS2323 ^(Note:) , they are:							
	1. \$000	\$000: \$1E (indicates manufactured by Atmel)						
	2. \$001	: \$91 ((indicates 2K bytes Flash memory)					
	3. \$002	2: \$02 (indicate	es AT90S/LS2323 when signature byte \$001 is \$91)				
	For AT90	OS/LS2	343 ^{(Note}	^{2:)} , they are:				
				es manufactured by Atmel)				
	2 \$001	· \$91 (indicate	es 2K bytes Flash memory)				

2. \$001: \$91 (indicates 2K bytes Flash memory)



	Instruction Format							
Instruction		Instr.1	Instr.2	Instr.3	Instr.4	Operation Remarks		
Read Fuse and Lock Bits (AT90S/ LS2323)	PB0 PB1 PB2	0_0000_0100_00 0_0100_1100_00 x_xxxx_xxx	0_0000_0000_00 0_0111_1000_00 x_xxxx_xxx	0_0000_0000_00 0_0111_1100_00 <i>1_2</i> Sxx_xxRx_xx		Reading <i>1</i> , <i>2</i> , S , R = "0" means the Fuse/Lock bit is programmed.		
Read Fuse and Lock Bits (AT90S/ LS2343)	PB0 PB1 PB2	0_0000_0100_00 0_0100_1100_00 x_xxxx_xxx	0_0000_0000_00 0_0111_1000_00 x_xxxx_xxx	0_0000_0000_00 0_0111_1100_00 <i>1_2</i> \$xx_xx R x_xx		Reading <i>1</i> , <i>2</i> , S , R = "0" means the Fuse/Lock bit is programmed.		
Read Signature Bytes	PB0 PB1 PB2	0_0000_1000_00 0_0100_1100_00 x_xxxx_xxx	0_0000_00 bb _00 0_0000_1100_00 x_xxxx_xxxx_xx	0_0000_0000_00 0_0110_1000_00 x_xxxx_xxx	0_0000_0000_00 0_0110_1100_00 0_0000 _000x_xx	Repeat Instr.2 - Instr.4 for each signature byte address.		

Note: **a** = address high bits

b = address low bits

i = data in

o = data out

x = don't care

1 = Lock Bit1

2 = Lock Bit2

F = FSTRT Fuse

R = RCEN Fuse **S** = SPIEN Fuse

S = SFIEN FUSE





High-voltage Serial Programming Characteristics

Figure 34. High-voltage Serial Programming Timing

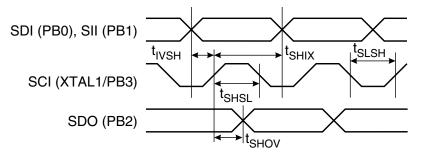


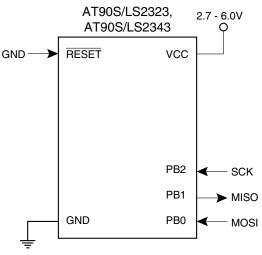
Table 17. High-voltage Serial Programming Characteristics, $T_A = 25^{\circ}C \pm 10^{\circ}$, $V_{CC} = 5.0V \pm 10^{\circ}$ (unless otherwise noted)

Symbol	Parameter	Min	Тур	Max	Units
t _{SHSL}	SCI (XTAL1/PB3) Pulse Width High	100.0			ns
t _{SLSH}	SCI (XTAL1/PB3) Pulse Width Low	100.0			ns
t _{IVSH}	t _{IVSH} SDI (PB0), SII (PB1) Valid to SCI (XTAL1/PB3) High				ns
t _{shix}	SDI (PB0), SII (PB1) Hold after SCI (XTAL1/PB3) High	50.0			ns
t _{SHOV}	SCI (XTAL1/PB3) High to SDO (PB2) Valid	10.0	16.0	32.0	ns
t _{WLWH_CE}	Wait after Instr.3 for Chip Erase	5.0	10.0	15.0	ms
t _{WLWH_PFB}	Wait after Instr.3 for Write Fuse Bits	1.0	1.5	1.8	ms

Low-voltage Serial Downloading

Both the program and data memory arrays can be programmed using the serial SPI bus while RESET is pulled to GND. The serial interface consists of pins SCK, MOSI (input) and MISO (output) (see Figure 35). After RESET is set low, the Programming Enable instruction needs to be executed first before program/erase instructions can be executed.

Figure 35. Low-voltage Serial Programming and Verify



For the EEPROM, an auto-erase cycle is provided within the self-timed Write instruction and there is no need to first execute the Chip Erase instruction. The Chip Erase instruction turns the content of every memory location in both the program and EEPROM arrays into \$FF.

The program and EEPROM memory arrays have separate address spaces: \$0000 to \$03FF for Flash program memory and \$000 to \$07F for EEPROM data memory.

Either an external clock is applied to the XTAL1/PB3 pin or the device must be clocked from the internal RC oscillator (AT90S/LS2343 only). The minimum low and high periods for the serial clock (SCK) input are defined as follows:

Low: > 2 MCU clock cycles

High: > 2 MCU clock cycles

Low-voltage SerialWhen writing serial data to the AT90S2323/2343, data is clocked on the rising edge ofProgramming AlgorithmSCK.

When reading data from the AT90S2323/2343, data is clocked on the falling edge of SCK. See Figure 36, Figure 37 and Table 20 for timing details.

To program and verify the AT90S2323/2343 in the low-voltage Serial Programming mode, the following sequence is recommended (see 4-byte instruction formats in Table 19):

1. Power-up sequence:

Apply power between V_{CC} and GND while RESET and SCK are set to "0". (If the programmer cannot guarantee that SCK is held low during power-up, RESET must be given a positive pulse after SCK has been set to "0".) If the device is programmed for external clocking, apply a 0 - 8 MHz clock to the XTAL1/PB3 pin. If the internal RC oscillator is selected as the clock source, no external clock source needs to be applied (AT90S/LS2343 only).

- 2. Wait for at least 20 ms and enable serial programming by sending the Programming Enable serial instruction to the MOSI (PB0) pin. Refer to the above section for minimum low and high periods for the serial clock input, SCK.
- 3. The serial programming instructions will not work if the communication is out of synchronization. When in sync, the second byte (\$53) will echo back when issuing the third byte of the Programming Enable instruction. Whether the echo is correct or not, all four bytes of the instruction must be transmitted. If the \$53 did not echo back, give SCK a positive pulse and issue a new Programming Enable instruction. If the \$53 is not seen within 32 attempts, there is no functional device connected.
- If a Chip Erase is performed (must be done to erase the Flash), wait t_{WD_ERASE} after the instruction, give RESET a positive pulse and start over from step 2. See Table 21 on page 46 for t_{WD ERASE} value.
- 5. The Flash or EEPROM array is programmed one byte at a time by supplying the address and data together with the appropriate Write instruction. An EEPROM memory location is first automatically erased before new data is written. Use Data Polling to detect when the next byte in the Flash or EEPROM can be written. If polling is not used, wait t_{WD_PROG} before transmitting the next instruction. See Table 22 on page 46 for t_{WD_PROG} value. In an erased device, no \$FFs in the data file(s) need to be programmed.
- 6. Any memory location can be verified by using the Read instruction, which returns the content at the selected address at the serial output MISO (PB1) pin.



AT90S/LS2323/2343

		Instructio					
Instruction	Byte 1 Byte 2		Byte 3	Byte 4	Operation		
Programming Enable	1010 1100	0101 0011	XXXX XXXX	XXXX XXXX	Enable Serial programming while RESET is low.		
Chip Erase	1010 1100	100x xxxx	XXXX XXXX	XXXX XXXX	Chip erase both Flash and EEPROM memory arrays.		
Read Program Memory	0010 H 000	0000 00 aa	bbbb bbbb	0000 0000	Read H (high or low) data o from program memory at word address a : b .		
Write Program Memory	0100 H 000	0000 00 aa	bbbb bbbb	iiii iiii	Write H (high or low) data i to program memory at word address a : b .		
Read EEPROM Memory	1010 0000	0000 0000	xbbb bbbb	0000 0000	Read data o from EEPROM memory at address b .		
Write EEPROM Memory	1100 0000	0000 0000	xbbb bbbb	1111 1111	Write data i to EEPROM memory at address b .		
Read Lock and Fuse Bits (AT90S/LS2323)	0101 1000	XXXX XXXX	XXXX XXXX	12Sx xxxF	Read Lock and Fuse bits. "0" = programmed, "1" = unprogrammed		
Read Lock and Fuse Bits (AT90S/LS2343)	0101 1000	XXXX XXXX	XXXX XXXX	12Sx xxxR	Read Lock and Fuse bits. "0" = programmed, "1" = unprogrammed		
Write Lock Bits	1010 1100	1111 1 21 1	XXXX XXXX	XXXX XXXX	Write Lock bits. Set bits 1 , 2 = "0" to program Lock bits.		
Write FSTRT Bit (AT90S/LS2323)	1010 1100	1011 111 F	XXXX XXXX	XXXX XXXX	Write FSTRT fuse. Set bit F = "0" to program, "1" to unprogram. ⁽²⁾		
Write RCEN Bit (AT90S/LS2343)	1010 1100	1011 111 R	XXXX XXXX	xxxx xxxx	Write RCEN Fuse. Set bit R = '0' to program, '1' to unprogram. ⁽²⁾		
Read Signature Bytes	0011 0000	XXXX XXXX	xxxx xx bb	0000 0000	Read signature byte o from address b . ⁽³⁾		

Table 19.	Low-voltage Seria	I Programming Instruc	tion Set AT90S2323/2343

Notes: 1. **a** = address high bits

b = address low bits

 $\mathbf{H} = 0 - \text{Low byte}, 1 - \text{High byte}$

 $\mathbf{o} = data \ out$

 $\mathbf{i} = data in$

- x = don't care
- **1** = lock bit 1
- **2** = lock bit 2
- **F** = FSTRT Fuse **R** = RCEN Fuse
- $\mathbf{S} = \text{SPIEN Fuse}$

2. When the state of the RCEN/FSTRT bit is changed, the device must be power cycled for the changes to have any effect.

3. The signature bytes are not readable in Lock mode 3, i.e., both Lock bits programmed.



Typical Characteristics

The following charts show typical behavior. These figures are not tested during manufacturing. All current consumption measurements are performed with all I/O pins configured as inputs and with internal pull-ups enabled. A sine wave generator with rail-to-rail output is used as clock source.

The current consumption is a function of several factors such as: operating voltage, operating frequency, loading of I/O pins, switching rate of I/O pins, code executed and ambient temperature. The dominating factors are operating voltage and frequency.

The current drawn from capacitive loaded pins may be estimated (for one pin) as $C_L \bullet V_{CC} \bullet f$ where C_L = load capacitance, V_{CC} = operating voltage and f = average switching frequency of I/O pin.

The parts are characterized at frequencies higher than test limits. Parts are not guaranteed to function properly at frequencies higher than the ordering code indicates.

The difference between current consumption in Power-down mode with Watchdog Timer enabled and Power-down mode with Watchdog Timer disabled represents the differential current drawn by the Watchdog Timer.



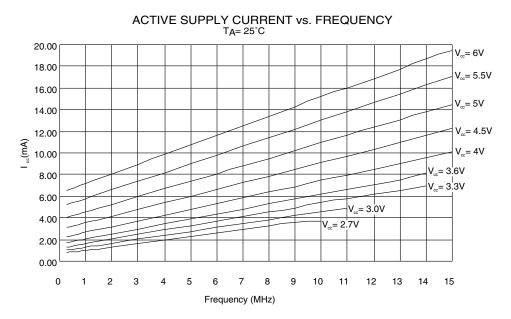






Figure 40. Active Supply Current vs. V_{CC}

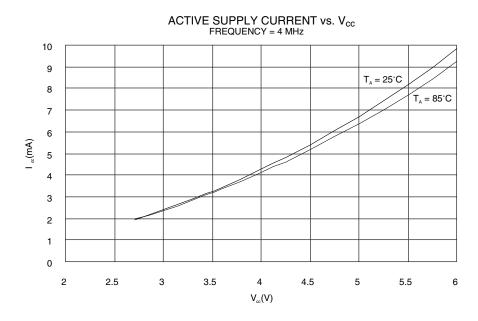
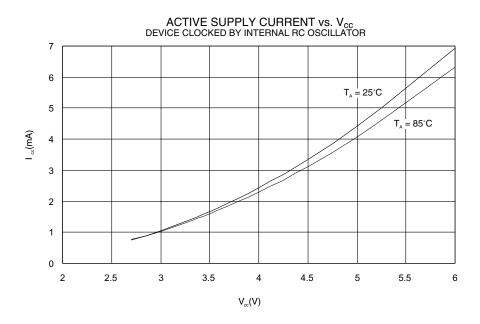


Figure 41. Active Supply Current vs. V_{CC}



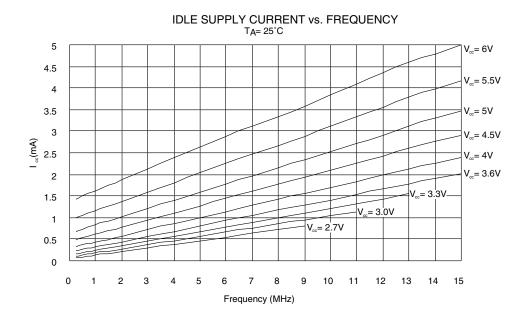
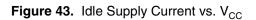
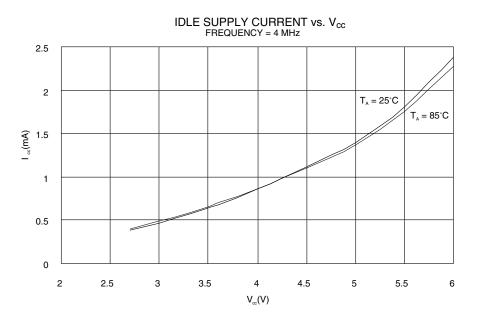


Figure 42. Idle Supply Current vs. Frequency









AT90S2323/2343 Register Summary

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
\$3F (\$5F)	SREG	I	Т	Н	S	V	Ν	Z	С	page 18
\$3E (\$5E)	Reserved		-			-		-		
\$3D (\$5D)	SPL	SP7	SP6	SP5	SP4	SP3	SP2	SP1	SP0	page 19
\$3C (\$5C)	Reserved									
\$3B (\$5B)	GIMSK	-	INT0	-	-	-	-	-	-	page 24
\$3A (\$5A)	GIFR	-	INTF0							page 25
\$39 (\$59)	TIMSK	-	-	-	-	-	-	TOIE0	-	page 25
\$38 (\$58)	TIFR	-	-	-	-	-	-	TOV0	-	page 25
\$37 (\$57)	Reserved									
\$36 (\$56)	Reserved			-						
\$35 (\$55)	MCUCR	-	-	SE	SM	-	-	ISC01	ISC00	page 26
\$34 (\$54)	MCUSR	-	-	-	-	-	-	EXTRF	PORF	page 23
\$33 (\$53)	TCCR0	-	-	-	-	-	CS02	CS01	CS00	page 29
\$32 (\$52)	TCNT0	Timer/Count	er0 (8 Bits)							page 30
\$31 (\$51)	Reserved									
\$30 (\$50)	Reserved									
\$2F (\$4F)	Reserved									
\$2E (\$4E)	Reserved									
\$2D (\$4D)	Reserved									
\$2C (\$4C)	Reserved									
\$2B (\$4B)	Reserved									
\$2A (\$4A)	Reserved									
\$29 (\$49)	Reserved									
\$28 (\$48)	Reserved									
\$27 (\$47)	Reserved									
\$26 (\$46)	Reserved									
\$25 (\$45)	Reserved									
\$24 (\$44)	Reserved									
\$23 (\$43)	Reserved									
\$22 (\$42)	Reserved									
\$21 (\$41)	WDTCR	-	-	-	WDTOE	WDE	WDP2	WDP1	WDP0	page 31
\$20 (\$40)	Reserved									
\$1F (\$3F)	Reserved									
\$1E (\$3E)	EEAR	-	EEPROM Ad	ddress Register						page 32
\$1D (\$3D)	EEDR	EEPROM D	ata Register							page 32
\$1C (\$3C)	EECR	-	-	-	-	-	EEMWE	EEWE	EERE	page 33
\$1B (\$3B)	Reserved									
\$1A (\$3A)	Reserved									
\$19 (\$39)	Reserved									
\$18 (\$38)	PORTB	-	-	-	PORTB4	PORTB3	PORTB2	PORTB1	PORTB0	page 35
\$17 (\$37)	DDRB	-	-	-	DDB4	DDB3	DDB2	DDB1	DDB0	page 35
\$16 (\$36)	PINB	-	-	-	PINB4	PINB3	PINB2	PINB1	PINB0	page 36
\$15 (\$35)	Reserved									
	Reserved									
\$00 (\$20)	Reserved									

Note:

te: 1. For compatibility with future devices, reserved bits should be written to zero if accessed. Reserved I/O memory addresses should never be written.

2. Some of the status flags are cleared by writing a logical "1" to them. Note that the CBI and SBI instructions will operate on all bits in the I/O register, writing a one back into any flag read as set, thus clearing the flag. The CBI and SBI instructions work with registers \$00 to \$1F only.

8S2

